

Data Sheet

DMM-3526-3-B

**Features:**

The DMM-3526-3-B digital MEMS microphone features a specialized pre-amplification ASIC that provides high sensitivity and high SNR output from a capacitive audio sensor. It's packaged for surface mounting and high temperature reflow assembly. The digital data format is single-bit PDM.

- -26dBFS sensitivity
- 65dB Signal-to-Noise
- Digital PDM output
- Small 2.65mm x 3.5mm surface-mount package

**Specifications** ( $f_{CLOCK} = 2.4\text{MHz}$ ,  $V_{DD} = 1.8\text{V}$ , unless otherwise specified.)

Parameter	Test Condition	Value	Unit
Sensitivity	94dB SPL $f_{IN} = 1\text{ kHz}$ All operating modes	-27 (min) -26 (typ) -25 (max)	dBFS
Supply Voltage		1.8 (typ)	$V_{DD}$
Supply Voltage Range		1.62 (min) 3.6 (max)	$V_{DD}$
Supply Current	$V_{dd} = 1.8\text{V}$ $f_{SAMPLE} = 3.072\text{MHz}$	550 (typ) 650 (max)	$\mu\text{A}$
Signal-to-Noise Ratio	$f_{IN} = 1\text{ kHz}$ 94dB SPL A-weighted	65 (typ)	dB
Frequency Range	See Frequency Response Curve for response limits	100 – 10k (typ)	Hz
Total Harmonic Distortion	$f_{IN} = 1\text{ kHz}$ 94dB SPL	0.5 (max)	%
Acoustic Overload Point (AOP)	$f_{IN} = 1\text{ kHz}$ 10% THD	121 (typ)	dB
Power Supply Rejection	100mV <sub>PP</sub> 217 Hz square wave on $V_{DD}$ A-weighted	-88 (typ)	dB
Phase Response	94dB SPL 50Hz < $f_{IN}$ < 2000Hz	-5 (min) 5 (max)	°

## Specifications (f<sub>CLOCK</sub> = 768kHz, V<sub>DD</sub> = 1.8V, unless otherwise specified.)

Parameter	Test Condition	Value	Unit
Sensitivity	94dB SPL f <sub>IN</sub> = 1 kHz All operating modes	-27 (min) -26 (typ) -25 (max)	dBFS
Supply Voltage		1.8 (typ)	V <sub>DD</sub>
Supply Voltage Range		1.6 (min) 3.6 (max)	V <sub>DD</sub>
Supply Current	V <sub>DD</sub> = 1.8V f <sub>SAMPLE</sub> = 768kHz	150 (typ) 350 (max)	μA
Signal-to-Noise Ratio	f <sub>IN</sub> = 1kHz 94dB SPL A-weighted	64 (typ)	dB
Frequency Range	See Frequency Response Curve for response limits	100 – 10k (typ)	Hz
Total Harmonic Distortion	f <sub>IN</sub> = 1kHz 94dB SPL	0.5 (max)	%
Acoustic Overload Point (AOP)	f <sub>IN</sub> = 1kHz 10% THD	121 (typ)	dB
Power Supply Rejection	100mV <sub>PP</sub> 217 Hz square wave on V <sub>DD</sub> A-weighted	-90 (typ)	dB

## Physical Properties

Parameter	Condition	Value	Unit
Directivity		Omnidirectional	
Weight		0.03 (max)	Grams
Operating Temperature		-40 (min) 85 (max)	°C
Storage Temperature		-40 (min) 100 (max)	°C
MSL (Moisture Sensitivity Level)*		Class 1	
Acceptable Soldering Methods		See page 3 for reflow soldering information	
Environmental Compliances		RoHS/REACH/ Halogen Free	

\*MSL level dependent on product remaining in sealed packaging until use

## Operating Ratings

Parameter	Test Condition	Value	Unit
Power Supply Voltage ( $V_{DD}$ )		1.62 (min) 1.8 (typ) 3.6 (max)	V
Clock Frequency Range ( $f_{CLOCK}$ )	Sleep Mode	310 (max)	kHz
	Lower Power Mode	380 (min) 768 (typ) 980 (max)	kHz
	Standard Mode	1.17 (min) 3.072 (typ) 3.1 (max)	MHz
Clock Duty Cycle		40 (min) 60 (max)	%
Input Logic High Level		$0.7 \cdot V_{DD}$ (min) $V_{DD} + 0.3$ (max)	V
Input Logic Low Level		-0.3 (min) $0.3 \cdot V_{DD}$ (max)	
Output Logic High Level		$0.7 \cdot V_{DD}$ (min)	V
Output Logic Low Level		$0.3 \cdot V_{DD}$ (max)	
Output Logic Load Capacitance		200 (max)	pF
Power On		20 (max)	ms
Startup Time		20 (max)	ms
Wake-up Time		10 (min)	ms
		20 (max)	
Supply Current	Clock is off	1 (typ) 10 (max)	$\mu$ A
	Standby	25 (typ) 50 (max)	
Short Circuit Current	Data Output Pin		mA
	$V_{DD} = 1.2V$	1 (min) 13 (max)	
	$V_{DD} = 1.8V$	1 (min) 20 (max)	

Note 1: For  $f_{CLOCK} \leq 2.7MHz$ , the duty-cycle must be in the 45% to 55% range. For  $f_{CLOCK} > 2.7MHz$ , the duty-cycle must be 48% - 52%.

## Timing Characteristics

Parameter	Test Condition	Value	Unit
<b>Clock Timing Characteristics</b>			
Clock Duty Cycle ( $DC_{CLOCK}$ )		40 (min) 60 (max)	%
Clock Rise Time ( $t_{CR}$ )	10% to 90%	13 (max)	ns
Clock Fall Time ( $t_{CF}$ )	90% to 10%	13 (max)	ns
Time Delay Between Clock Edge and Data Line Driven [DV <sub>DD</sub> Mode] ( $t_{DD\_DVDD}$ )	DV <sub>DD</sub> Digital Interface	30 (min)	ns
Time Delay to Valid Data [Normal Mode] ( $t_{DV\_NM}$ )	DV <sub>DD</sub> Digital Interface: $f_{CLOCK} = 768\text{kHz}, 2.0\text{MHz}, 3.072\text{MHz}, \text{ or } 4.0\text{MHz}$ Internal 1.2V Digital Interface: $f_{CLOCK} = 2.0\text{MHz}, 3.072\text{MHz}, \text{ or } 4.0\text{MHz}$	100 (max)	ns
<b>Data Timing Characteristics</b>			
Time Delay Between Clock Edge and Data Line Driven ( $t_{DD}$ )	Clock Edge Magnitude = 50%V <sub>DD</sub>	40 (min) 80 (max)	ns
Time Delay to Valid Data [Normal Mode] ( $t_{DV}$ )	DV <sub>DD</sub> Digital Interface: $f_{CLOCK} = 768\text{kHz}, 2.0\text{MHz}, 3.072\text{MHz}, \text{ or } 4.0\text{MHz}$ Internal 1.2V Digital Interface: $f_{CLOCK} = 2.0\text{MHz}, 3.072\text{MHz}, \text{ or } 4.0\text{MHz}$	100 (max)	ns
Time Delay to High Impedance ( $t_{HZ}$ )	DV <sub>DD</sub> Digital Interface	5 (min) 30 (min)	ns
Time to Sleep	$f_{CLK} < 250\text{kHz}$	10 (max)	ms
Time to Wake	$f_{CLK} > 350\text{kHz}$	15 (max)	ms
Time from Power Valid to Operation		50 (max)	ms
Time to Change Mode		10 (max)	ms
Time to Valid V <sub>DD</sub>	$V_{DD} \geq V_{DD\_min}$	50 (max)	ms
Power-On Time to Idle Data Pattern		4 (max)	ms
Power-On Time to Valid Data Pattern		21.5 (max)	ms
Startup Time (Note 2)	Sensitivity accuracy = $\pm 0.5\text{dB}$	21.5 (min)	ms
	Sensitivity accuracy = $\pm 0.2\text{dB}$	50 (max)	
Mode Switch Time (Note 3)	Sensitivity accuracy = $\pm 0.5\text{dB}$	2 (min)	
	Sensitivity accuracy = $\pm 0.2\text{dB}$	20 (max)	
Mode Switch Time (Note 4)	Sensitivity accuracy = $\pm 0.5\text{dB}$	21.5 (min)	
	Sensitivity accuracy = $\pm 0.2\text{dB}$	50 (max)	

Note 2: Any mode after  $V_{DD}$  and CLOCK are applied.

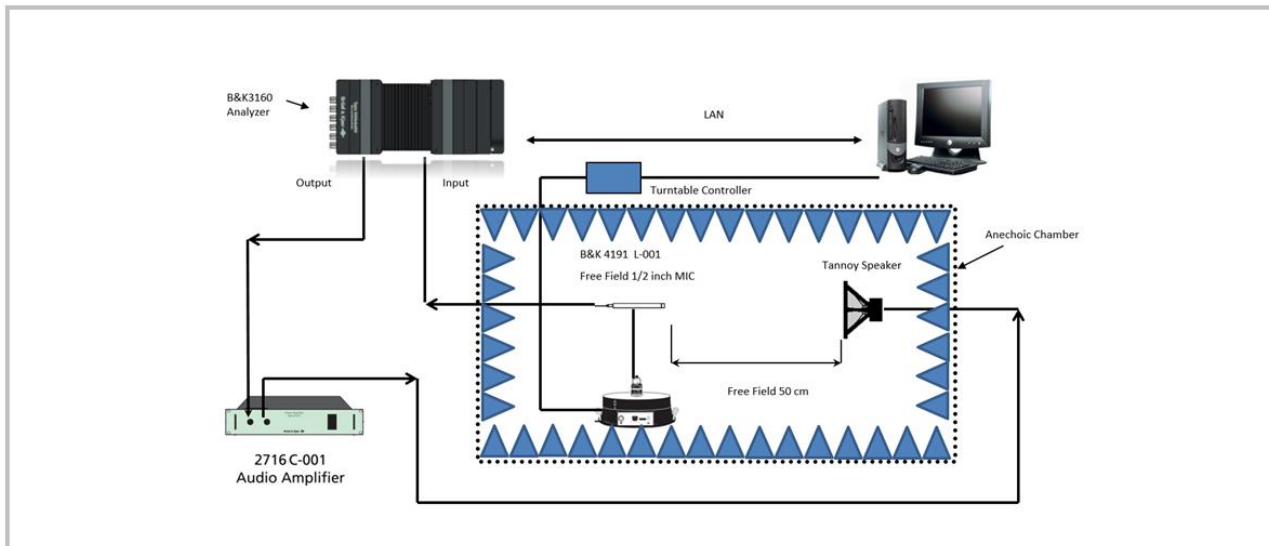
Note 3: Time to switch to low-power mode  $f_{CLOCK}$  range of 380kHz to 980kHz.

Note 4: Switching between any mode;  $1.6V \leq V_{DD} \leq 3.6V$ .

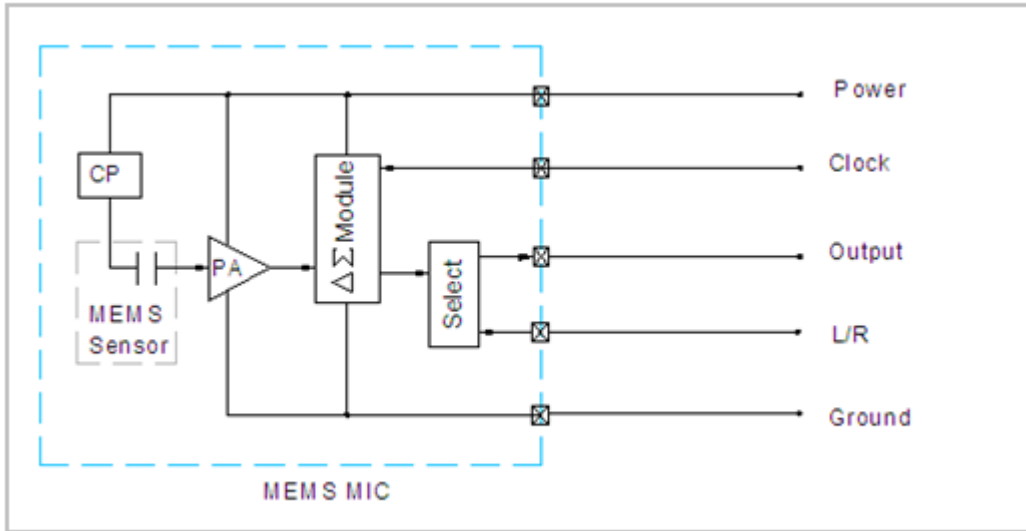
## Absolute Maximum Ratings

Parameter	Condition	Value	Unit
Supply Voltage ( $V_{DD}$ )		3.6 (max)	$V_{DC}$
Voltage on Any Pin		-0.3 (min) $V_{DD} + 0.3$ (max)	$V_{DC}$
Max Sound Pressure Level		160	dB
Max Mechanical Shock		10000	G
Max Vibration		Pre-MIL-STD-883 Method 2007, Test Condition B	

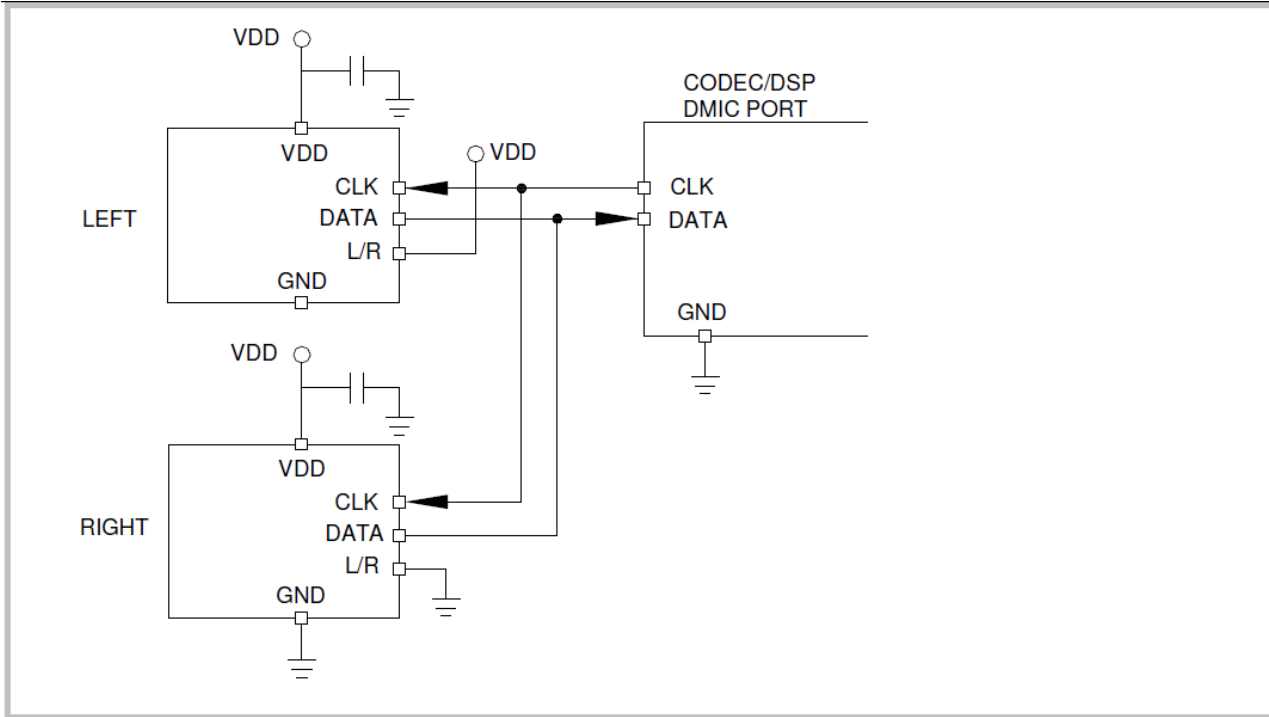
## Measurement Method



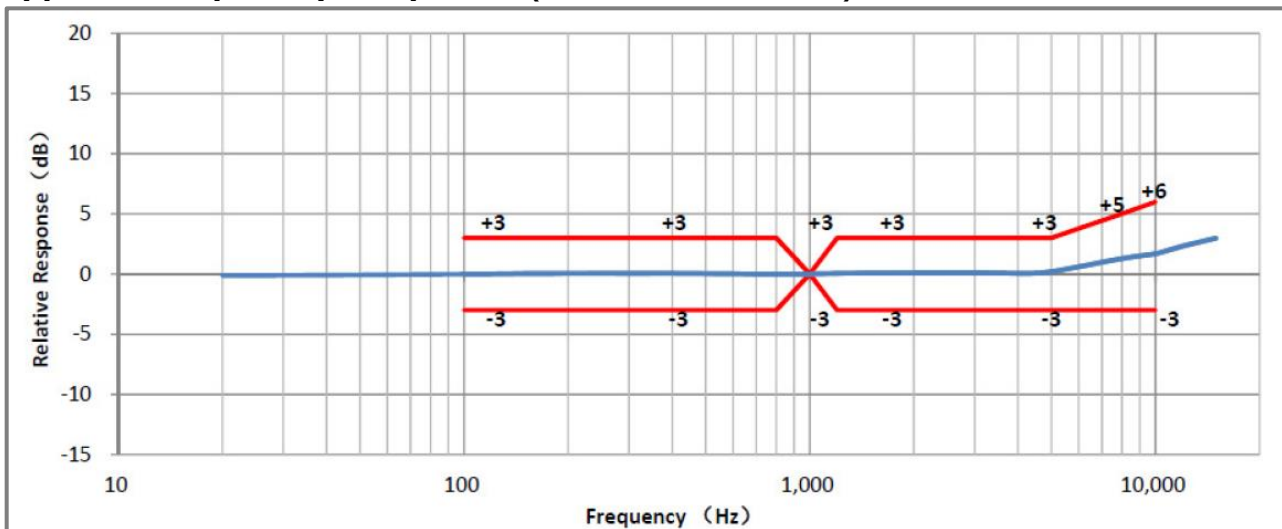
## Measurement Circuit



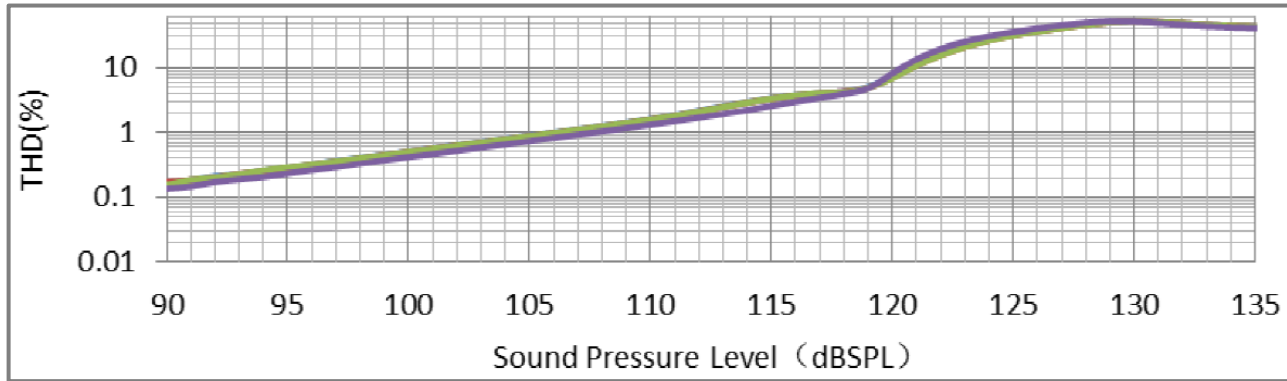
## Connection Diagram



## Typical Frequency Response (Normalized to 0dB at 1kHz)

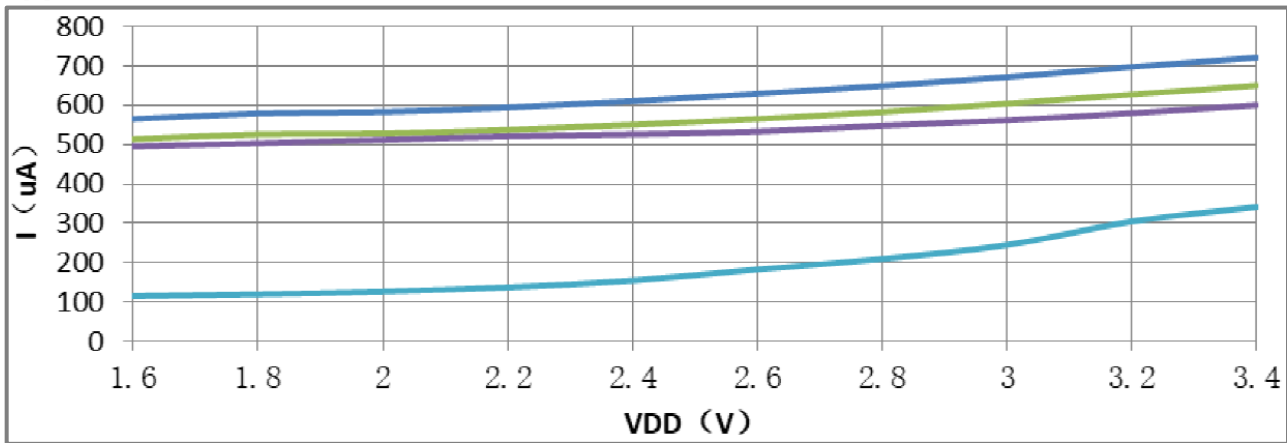


### Typical THD vs. Sound Pressure Level



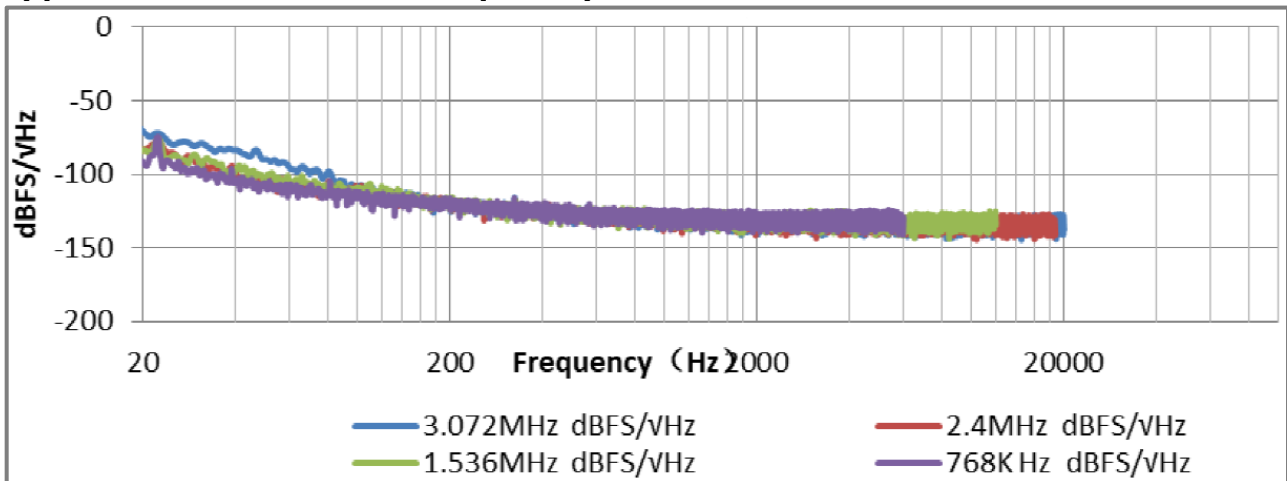
f<sub>CLOCK</sub>: — = 3.072MHz; — = 2.400MHz; — = 1.536MHz; — = 0.768MHz

### Typical I<sub>DD</sub> vs. V<sub>DD</sub>



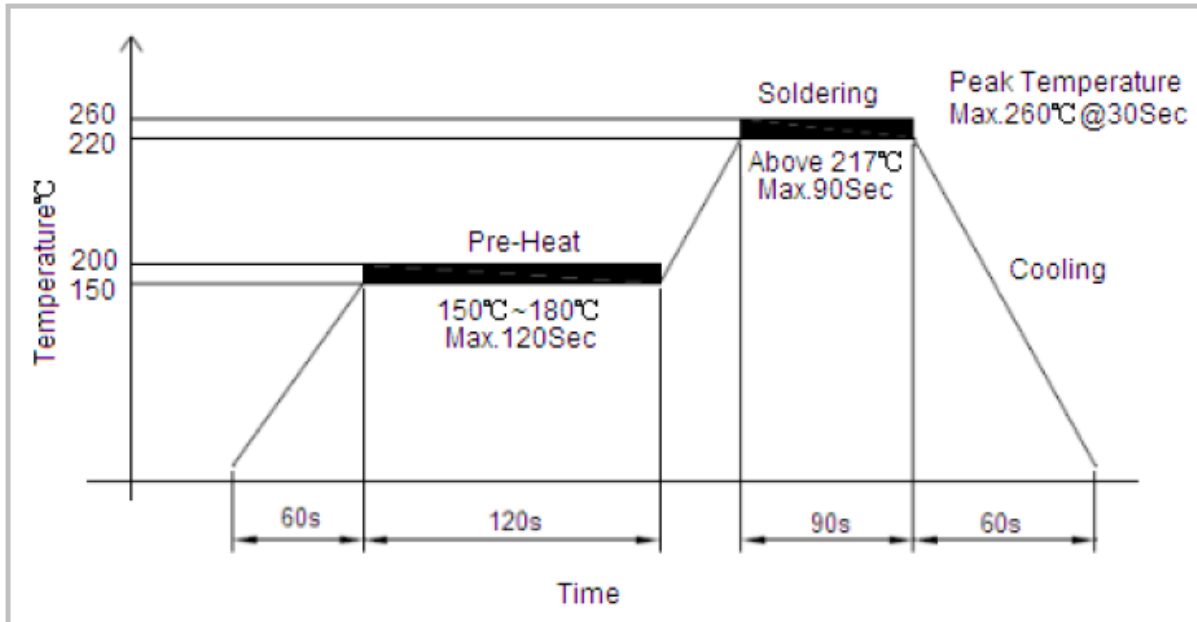
f<sub>CLOCK</sub>: — = 3.072MHz; — = 2.400MHz; — = 1.536MHz; — = 0.768MHz

### Typical Noise Floor vs. Frequency





## Recommended Reflow Soldering Procedure (Recommended profile, temperature $\leq 260^{\circ}\text{C}$ , 30s maximum at peak temperature)



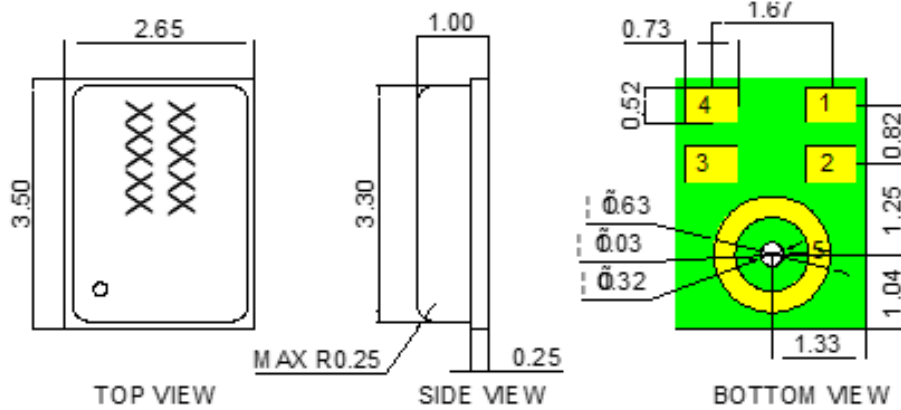
Important notes to minimize device damage

1. Do not handle the microphone with pick-and-place vacuum tools that could contact the microphone acoustic port hole.
2. Never expose the microphone's acoustic port hole to vacuum. Such exposure can damage or destroy the MEMS element.
3. Never allow air to blow air into the microphone acoustic port hole. The port hole must be sealed to prevent particle contamination if a blown air-cleaning process is used,
4. A clean room environment is recommended for PCB assembly to avoid microphone contamination.
5. Do not use blown air or ultrasonic cleaning procedures on MEMS Microphones. A no-clean paste is recommended for the assembly, avoiding subsequent cleaning steps. cleaning substances can severely damage the microphone MEMS element.
6. it is recommended to cover the sound port with protective tape during PCB sawing or system assembly. This prevents blocking or partially blocking the acoustic port hole during PCB assembly.
7. Do not use excessive force to place the microphone on the PCB. Use industry standard pick and place tools to limit the mechanical force exerted on the package.

**Reliability Testing** (Samples under test are acclimated at  $T_A = 23 \pm 2^\circ\text{C}$ , R.H. =  $55 \pm 10\%$  for two hours. After each test completes and corresponding recovery time (if applicable) elapses, any measured sensitivity change is  $\leq \pm 3\text{dB}$ , unless otherwise specified)

Type of Test	Test Specifications
High Temperature Storage Test	1000hrs at $105 \pm 3^\circ\text{C}$ , two-hour recovery
High Temperature Operational Test	1000hrs at $105 \pm 3^\circ\text{C}$ , $V_{DD} = V_{DD}(\text{max})$ , four-hour recovery
Low Temperature Storage Test	1000hrs at $-40 \pm 3^\circ\text{C}$ , two-hour recovery
Low Temperature Operational Test	1000hrs at $-40 \pm 3^\circ\text{C}$ , $V_{DD} = V_{DD}(\text{max})$ , four-hour recovery
High Humidity, High Temperature Operating Test	1000hrs at $85 \pm 3^\circ\text{C}$ and 85%RH, $V_{DD} = V_{DD}(\text{max})$ , twelve-hour recovery, no corrosion or defamation inside the microphone
High Humidity, High Temperature Operating Test	168hrs at $65 \pm 3^\circ\text{C}$ and 95%RH, $V_{DD} = V_{DD}(\text{max})$ , twelve-hour recovery, no corrosion or defamation inside the microphone
Temperature-Cycle Testing	Double-case method: 15min at $-40 \pm 3^\circ\text{C}$ Followed by 15min at $125 \pm 3^\circ\text{C}$ 100 cycles, two-hour recovery
Vibration Test	Twelve minutes along the x, y, and z axis $f_{IN} = 20\text{Hz}$ to $2\text{kHz}$ 20G peak acceleration Two-hour recovery Less than 1dB sensitivity change
Shock Test	10000g, 0.1ms pulse width 3 times each along X/Y/Z axes Less than 1dB sensitivity change
Drop Test	Height: 1.5m Fixture weight: $150 \pm 10\text{g}$ Fixture's sound hole diameter is $\geq 0.8\text{mm}$ Reference surface is marble floor Duration: four corners x four times; six faces x four times Less than 1dB sensitivity change

## Dimensions (Dimension are in mm.)



Laser Mark	Description
XXXXX XXXXX	Date Code

Item	Dimension	Tolerance(+/-)	Units
Length(L)	3.50	0.10	mm
Width(W)	2.65	0.10	mm
Height(H)	0.98	0.10	mm
Acoustic Port(AP)	Ø0.32	0.05	mm

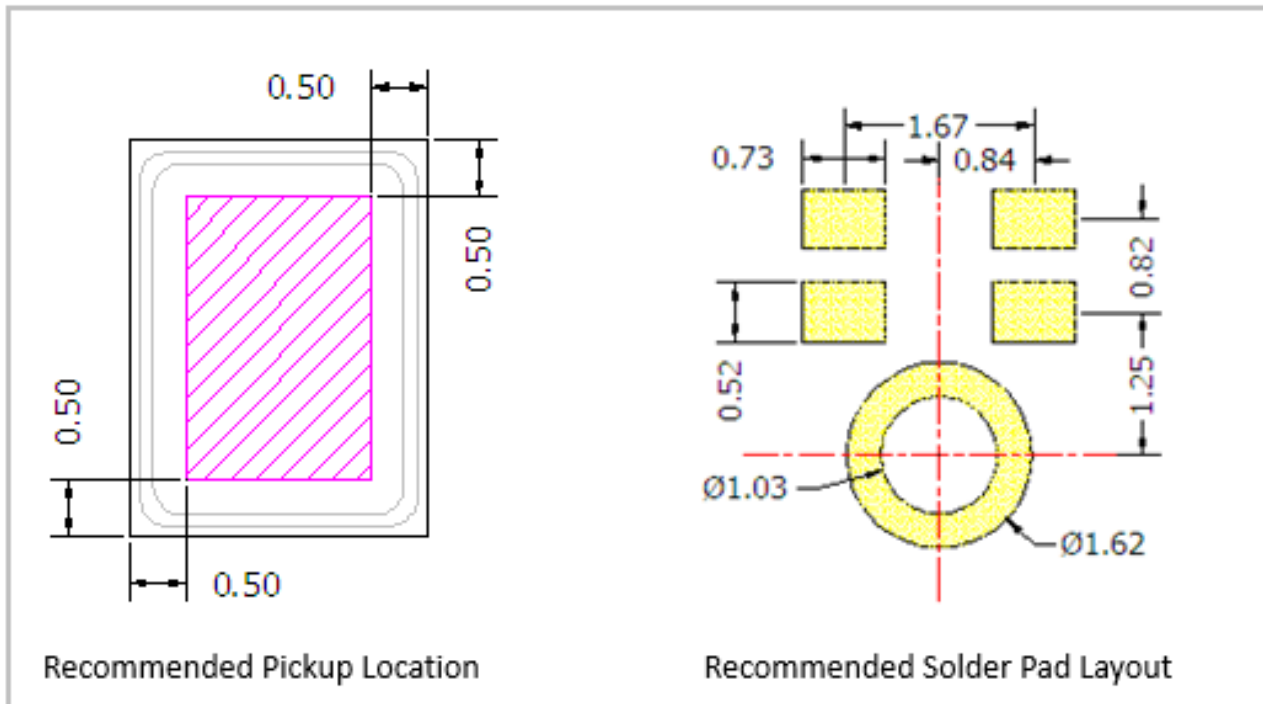
Pin #	Pin Name	Type	Description
1	Output	Signal	Output Signal
2	L/R	L/R Channel	Channel select
3	CLK	Clock	Clock input
4	VDD	Power	Power Supply
5	GND	Ground	Ground

### Notes:

All dimensions are in millimeter (mm).

Tolerance±0.15mm unless otherwise specified.

## Suggested Land Pattern\*



\*This land pattern is advisory only and its use or adaptation is entirely voluntary. PUI Audio disclaims all liability of any kind associated with the use, application, or adaptation of this land pattern.

## Packaging

